

TR-52D

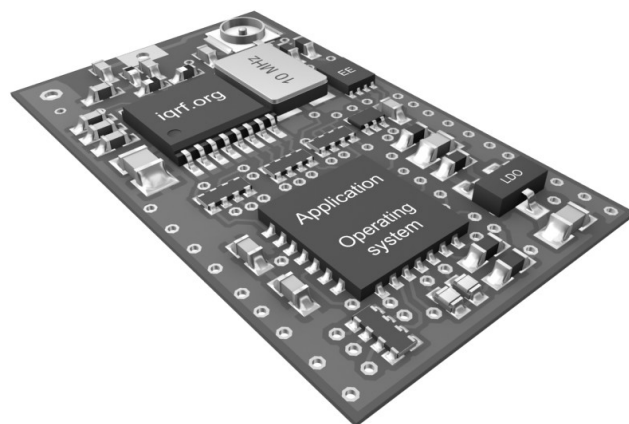
Transceiver Module

Data Sheet



Description

TR-52D is a family of IQRF transceiver modules operating in the 868 MHz and 916 MHz license free ISM (Industry, Scientific and Medical) frequency band. Its highly integrated ready-to-use design requires no external components. Microcontroller with built-in operating system, excellent development support, integrated LDO regulator, serial EEPROM and optional temperature sensor dramatically reduce time of application development. Ultra low power consumption predetermines these modules for use in battery powered applications.



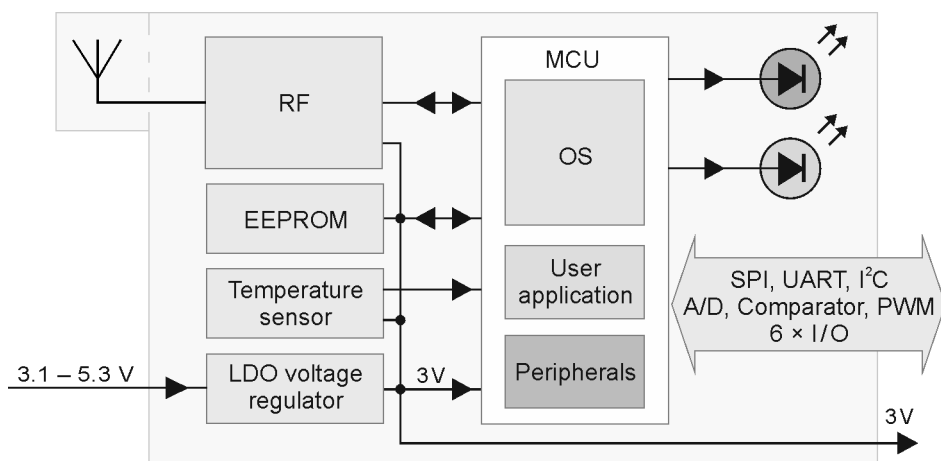
Key features

- Complete solution with operating system, easy to use
- FSK modulation
- Selectable RF band 868 / 916 MHz, multiple channel
- MCU with extended resources, user interrupt capability
- Extra low power consumption, power management modes
- SPI interface supported by OS on background
- Serial EEPROM
- PWM output
- Programmable HW timer
- +3 V LDO regulator output, battery monitoring
- 2 LEDs
- 8 pins, 6 I/Os
- A/D converter (2 channels), analog comparator
- Options: on-board antenna, U.FL connector, temperature sensor
- SIM card format

Applications

- Telemetry
- Building automation
- Wireless control & regulation
- Access control
- Remote data acquisition
- Communication links
- RF connectivity in many other areas

Block diagram



Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications.

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Electrical specifications

Typical values unless otherwise stated

Parameters specified in this datasheet are typical values. They are at power supply $V_{OUT} = 3\text{ V}$ only. V_{OUT} voltage different from 3 V can impact on RF range and other parameters.

Supply voltage (V_{CC})	3.1 V to 5.3 V
LDO output (V_{OUT})	+3 V \pm 60 mV ($V_{CC} > 3.1\text{ V}$), 100 mA max.
Operating temperature ¹	-40 °C to +85 °C
Supply current	
Sleep mode	1.9 μ A (if all peripherals including MRF49XA disabled ³)
Run mode	1 mA (MRF49XA disabled)
Additional LED supply current	cca 2 mA (if one or two LEDs on). Rough value for brief guidance only.
RX mode	STD mode: 13 mA LP mode ⁴ : OS v3.01D: 400 μ A, from OS v3.02D: 330 μ A XLP mode ⁴ : OS v3.01D: 35 μ A, from OS v3.02D: 25 μ A
TX mode	14 mA – 24 mA (according to RF output power)
RF Band	868 MHz or 916 MHz (software selectable)
Channels	See IQRF OS User's guide, Appendix 2, Channel maps
RF data modulation	FSK (frequency-shift keying)
RF data transmission bit rate	1.2 kb/s ⁵ , 19.2 kb/s, 57.6 kb/s ⁵ , 86.2 kb/s ⁵
RFIC RF sensitivity	See MRF49XA datasheet
RFIC RF output power	Programmable in 8 levels (0 – 7), -2.5 dBm/level, see MRF49XA datasheet
RF range (TR-52DAx) ²	Up to 300 m @ 19.2 kb/s ⁵
Input voltage on C1, C2, C5 to C8 pins	0 V to V_{OUT}
A/D converter	10 bit, 2 inputs, see PIC16LF1938 datasheet
Temperature sensor	TMP112 (for TR-52DT and TR-52DxT only)
Size (L x W x H)	25.0 mm x 14.9 mm x 2.0 mm 31.8 mm x 14.9 mm x 2.0 mm (TR-52DA)

Note 1: RF range may change with lower temperature. Frost, condensation or humidity over 85% may disable module functionality. Module suitability should be tested in final application before volume use.

Note 2: RF range strongly depends on module orientation and surroundings.

Note 3: Additional current is consumed when a peripheral (e.g. watchdog, Brown-out detection etc.) is enabled.

Note 4: Depends on interferences.

Note 5: RF bit rates different from 19.2 kb/s are preliminary, for experimental purpose only.

Users have to ensure observing local provisions and restrictions relating to the use of short range devices by software, e.g. the CEPT ERC/REC 70-03 Recommendation and subsequent amendments in EU.

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.*
- Increase the separation between the equipment and receiver.*
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.*
- Consult the dealer or an experienced radio/ TV technician for help.*

TR modules with metallic shielding of RF circuitry (with the “F” postfix, e.g. TR-52DF) must be used in countries where FCC provision is valid.

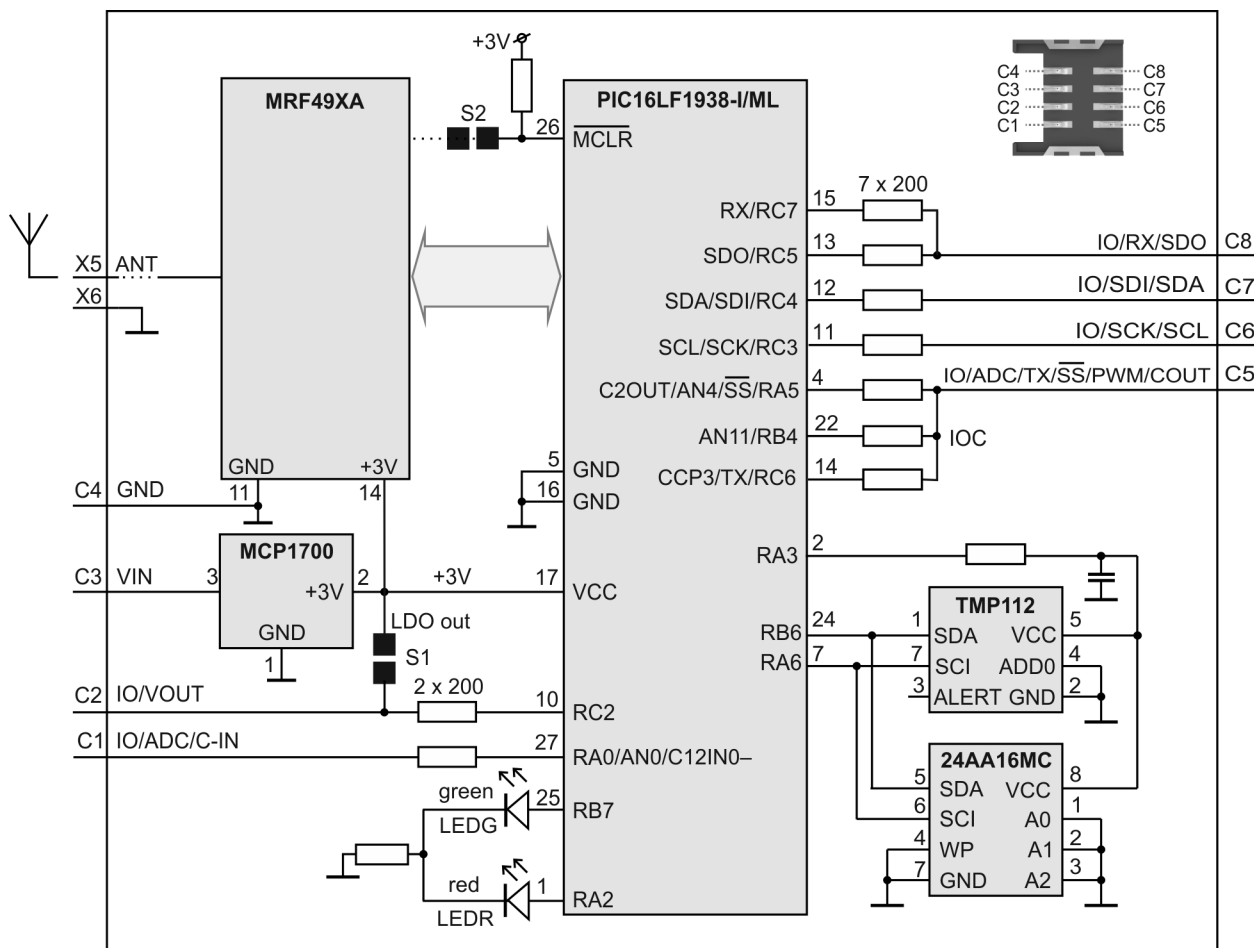
Caution: *Electrostatic sensitive device. Observe appropriate precautions for handling*

Absolute maximum ratings

Stresses above listed maximum values may cause permanent damage to the device and affect device reliability. Functional operation at these or any other conditions beyond those specified is not supported.

Supply voltage (V_{CC})	5.5 V
Voltage on C1, C2, C5 to C8 pins vs. GND	-0.3 V to ($V_{OUT} + 0.3$ V)
Storage temperature	-40 °C to +85 °C
Ambient temperature under bias	-40 °C to +85 °C

Simplified schematic



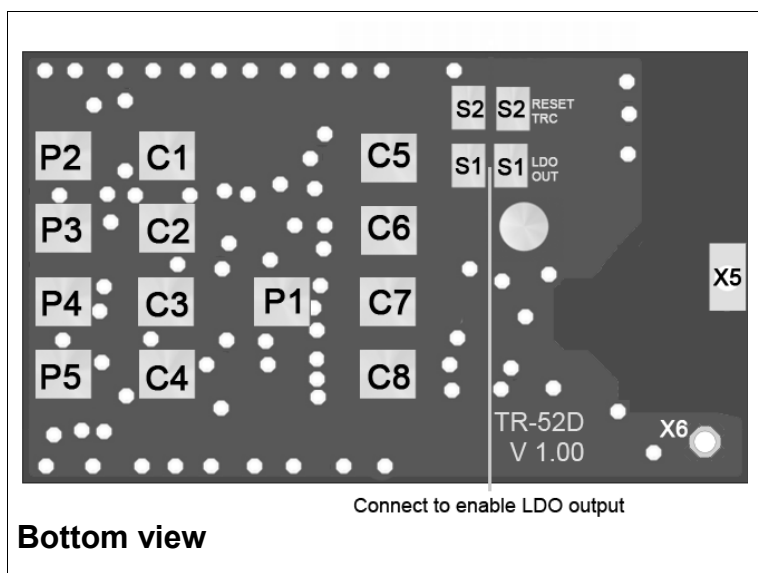
Basic components

IC	Type	Manufacturer	Note
MCU	PIC16LF1938–I/ML	Microchip	
RF IC	MRF49XA	Microchip	
LDO voltage regulator	MCP1700	Microchip	
Temperature sensor	TMP112	Texas Instruments	TR-52DT, TR-52DCT and TR-52DAT only
EEPROM	24AA16/MC	Microchip	

For more information refer to datasheets of ICs used.

Pin	Name	Description
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C1	IO/ADC/C-IN	
	RA0	General I/O pin
	AN0	Analog A/D input
	C12IN0	Comparator –input
C2	IO/VOUT	
	RC2	General I/O pin (S1 disconnected)
	VOUT	On-board +3 V LDO output (S1 connected)
C3	VIN	Power supply voltage
C4	GND	Ground
C5	IO/ADC/TX/-SS /PWM/COUT	
	RA5	General I/O pin,
	-SS	SPI Slave select
	AN4	Analog A/D input
	C2OUT	Comparator output
	RC6	General I/O pin
	TX	UART TX
	CCP3	PWM output
	RB4	General I/O pin, programmable pull-up and interrupt/wake-up on change (IOC)
	AN11	Analog A/D input
C6	IO/SCK/SCL	
	RC3	General I/O pin
	SCK	SPI clock input
	SCL	I ² C clock
C7	IO/SDI/SDA	
	RC4	General I/O pin
	SDI	SPI data
	SDA	I ² C data
C8	IO/RX/SDO⁶	
	RC5	General I/O pin
	SDO	SPI data out
	RC7	General I/O pin
	RX	UART RX
X5	ANT	Antenna input
X6	GND	Ground
P1–P5		For manufacturer only
S1		LDO output enable. Connect to enable (default disabled).
S2		Leave disconnected.



Note 6: This pin is used as output during initial ~250 ms boot-up to recognize programming mode.

Figure 1: Relative RF range vs. level for the `setTxpower(level)` function. Refer to IQRF OS Reference guide.

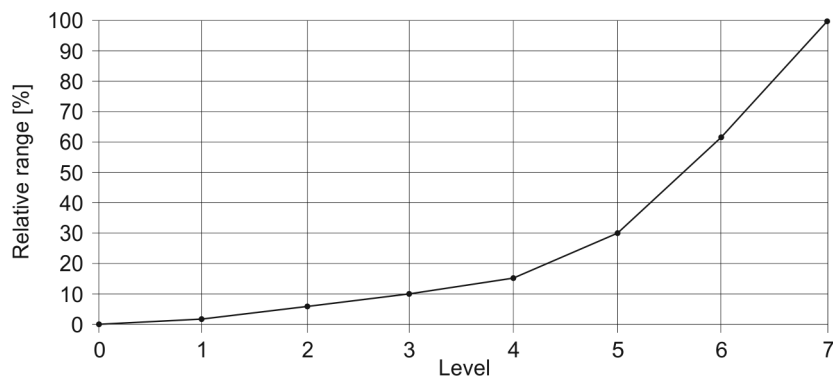


Figure 2: Relative RF range vs. level for the `checkRF(level)` function. Refer to IQRF OS Reference guide.

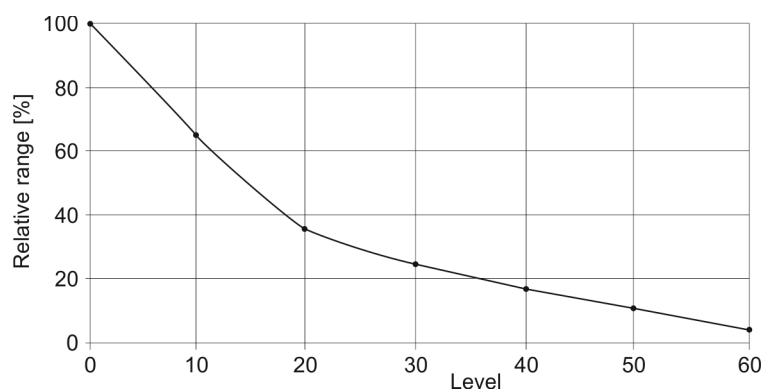
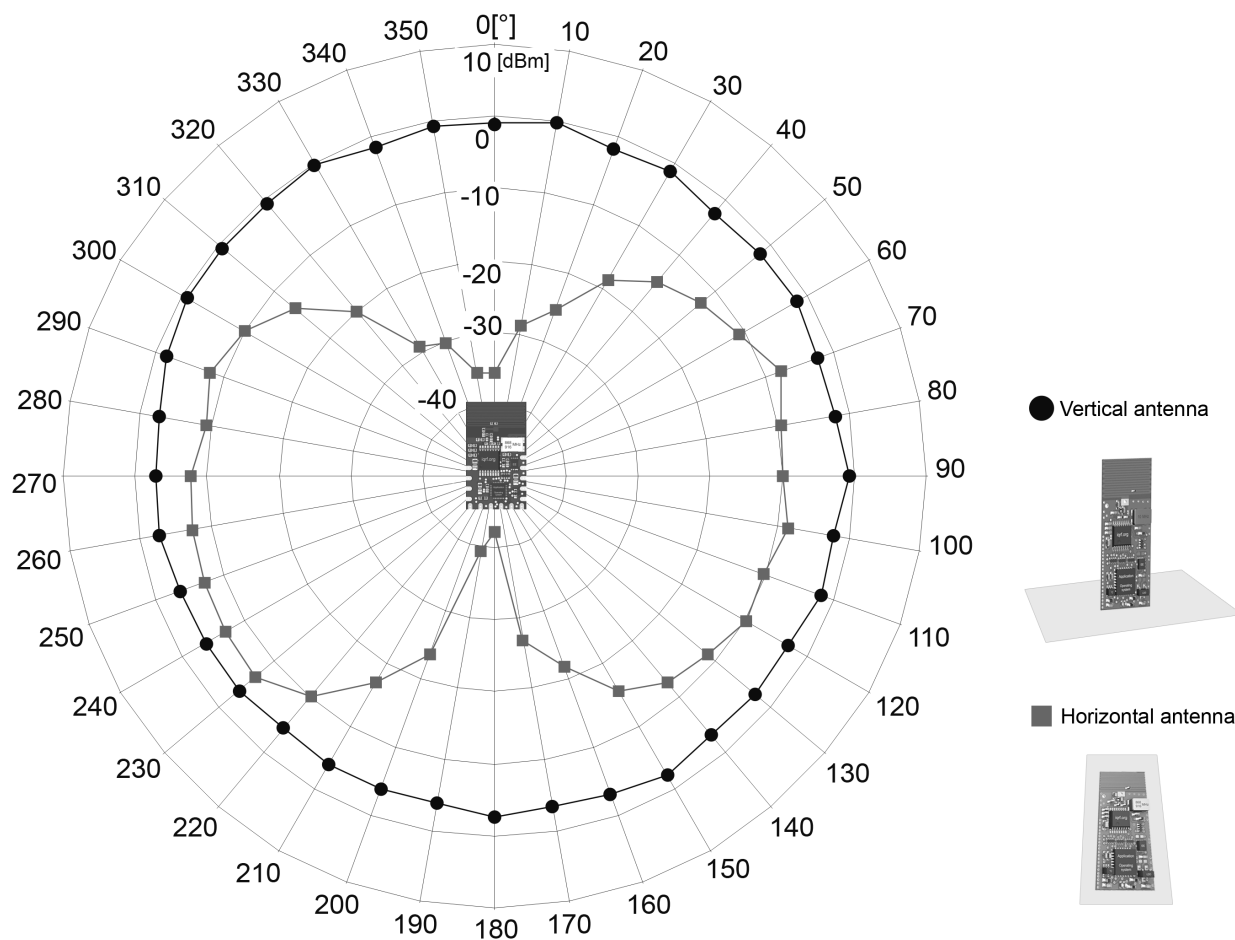


Figure 3: TR-52DA relative RF range vs. antenna orientation (radiation patterns)



Relative decrease of RF input signal vs. antenna edge spacing to conductive areas

Conductive areas close to the antenna must be avoided.

Figure 4: Perpendicular arrangement

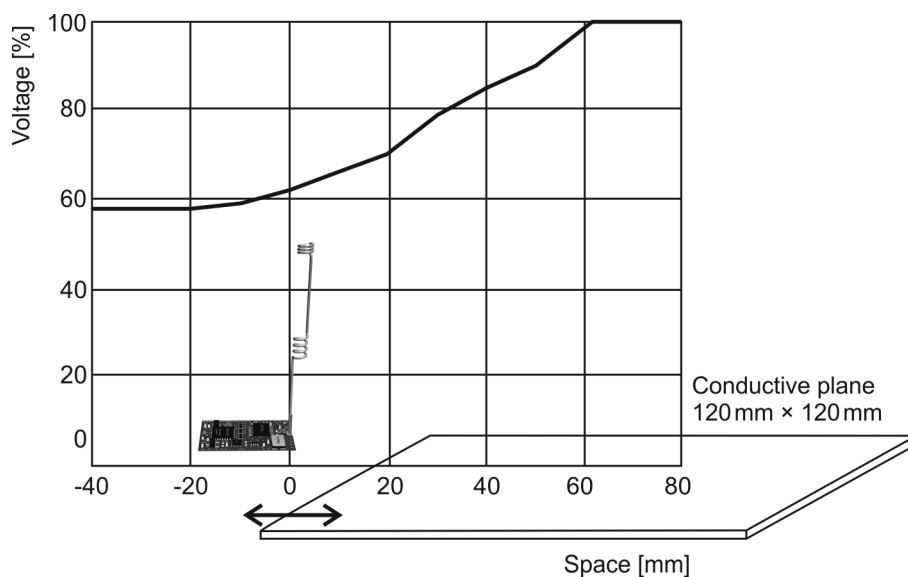
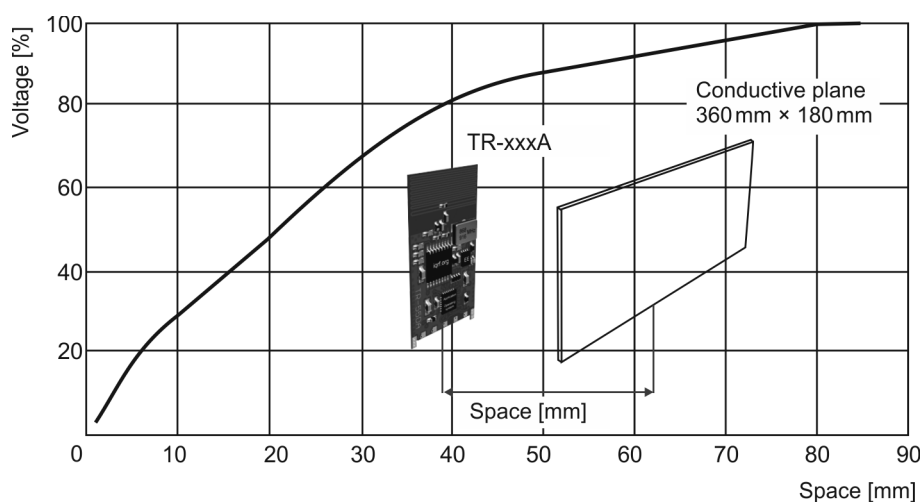
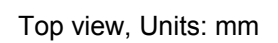


Figure 5: Parallel arrangement



TR-52D(C)(T)



Application

Assembly

TR-52Dx modules should be mounted in SIM connector. They are not intended for SMT reflow soldering. Recommended SIM connector: KON-SIM-01.

Operating system

See IQRF OS User's guide and IQRF OS Reference guide.

Software

See Application examples on www.iqrf.org website.

Programming

There are three possibilities to upload an application program in TR-52Dx modules:

- Wired upload with TR-52Dx plugged via the SIM connector in the CK-USB-04 programmer.
- For TR-52Dx modules plugged in an application:
 - Wired upload using the CK-USB-04 programmer and the KON-TR-01P adapter. See the KON-TR-01P User's guide.
 - RFPGM – RF programming™ (wireless upload). See the IQRF OS User's guide, chapter *RF programming*.

Product information

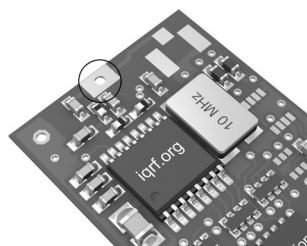
Ordering codes

T R - 5 2 D A PP

- Peripheral options:
- nil - No other option
 - T - Temperature sensor
 - F - RF shielding
- Antenna options:
- nil - soldering padhole (no antenna, no U.FL connector)
 - A - PCB antenna,
 - C - U.FL connector (mini coax)

Type	Antenna connection	Temperature sensor	RF shielding
TR-52D	Soldering hole	–	–
TR-52DC	U.FL connector	–	–
TR-52DA	PCB antenna	–	–
TR-52DF	Soldering hole	–	Yes
TR-52DCF	U.FL connector	–	Yes
TR-52DAF	PCB antenna	–	Yes

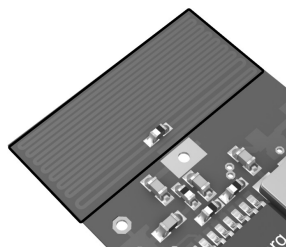
Type	Antenna connection	Temperature sensor	RF shielding
TR-52DT	Soldering hole	Yes	–
TR-52DCT	U.FL connector	Yes	–
TR-52DAT	PCB antenna	Yes	–
TR-52DTF	Soldering hole	Yes	Yes
TR-52DCTF	U.FL connector	Yes	Yes
TR-52DATF	PCB antenna	Yes	Yes



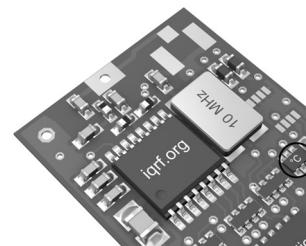
TR-52D



TR-52DC



TR-52DA



TR-52DT



TR-52DF

Document history

- 140805 FCC statements regarding harmful interference added.
- 140430 RF range revised.
- 140120 Datasheet file renamed from DS_TR-52D_131114 to Datasheet_TR-52D_140120.
- 131114 Certification updated for the latest directives.
- 130906 F-option with RF shielding available. Electrical specification simplified.
- 130607 Operational temperature range extended.
- 130405 Chapters *Specifications* and *Application* precised.
- 121001 Information about PWM and analog comparator added.
- 120831 Power consumption for OS v3.02D added.
- 120810 Electrical specification slightly precised. Some minor improvements.
- 120622 Block schematics and Table 6 added.
- 120518 Power consumption in Sleep updated. Version without serial EEPROM cancelled.
- 120425 RF range specified.
- 120322 Slightly improved. Fig. 4 added. Preliminary.
- 111011 Temperature sensor available optionally. Preliminary.
- 110919 Preliminary

Sales and Service

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Complies with FCC directives FCC CFR, Title 47, Part 15, Section 15.209, FCC CFR, Title 47, Part 15, Section 15.249

Complies with Directive 2002/95/EC (RoHS)



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